



TS931
TS932
TS934

OUTPUT RAIL TO RAIL MICROPOWER OPERATIONAL AMPLIFIERS

- RAIL TO RAIL **OUTPUT** VOLTAGE SWING
- **MICROPOWER** CONSUMPTION (**20 μ A**)
- SINGLE SUPPLY OPERATION (**2.7V to 10V**)
- **LOW OFFSET** (**2mV max** for TS93xB)
- **CMOS INPUTS**
- **ULTRA LOW INPUT BIAS CURRENT** (**1pA**)
- **ESD PROTECTION** (**2kV**)
- **LATCH-UP IMMUNITY** (**Class A**)
- AVAILABLE IN **SOT23-5 MICROPACKAGE**

DESCRIPTION

The TS93x (Single, Dual & Quad) is Operational Amplifier able to operate with voltage as low as 2.7V and to reach 2.9Vpp of output swing with $R_L = 100k\Omega$ when supplied @ 3V. Offering a typical consumption of only 20 μ A, it is particularly well-suited for every kind of battery-supplied applications.

The TS93x is housed in the space-saving 5 pins SOT23-5 package which simplifies the board design because of the ability to be placed everywhere (outside dimensions are : 2.8mm x 2.9mm).

APPLICATION

- Battery-powered systems
- Portable communication systems
- Alarm, smoke detectors
- Instrumentation & sensing
- PH Meter
- Digital scales

ORDER CODE

Part Number	Temperature Range	Package				SOT23 Marking
		N	D	P	L	
TS931I TS931A/BI	-40, +85°C		•		•	K205 K206/207
TS932I TS932A/BI	-40, +85°C	•	•			
TS934I TS934A/BI	-40, +85°C	•	•	•		

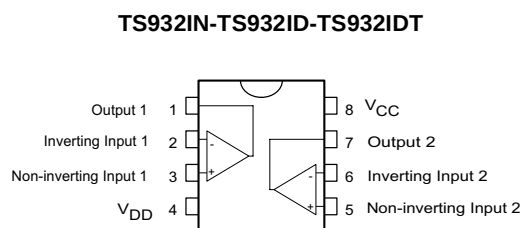
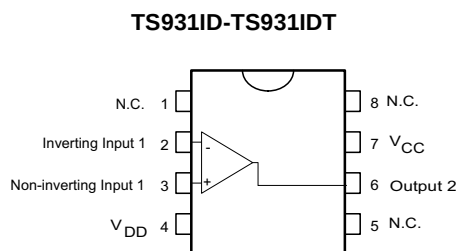
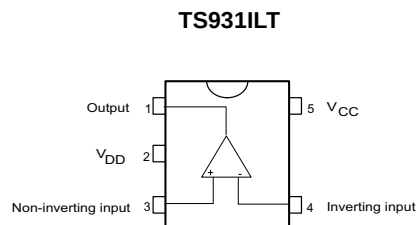
N = Dual in Line Package (DIP)

D = Small Outline Package (SO) - also available in Tape & Reel (DT)

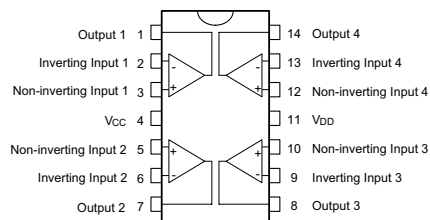
P = Thin Shrink Small Outline Package (TSSOP) - only available in Tape & Reel (PT)

L = Tiny Package (SOT23-5) - only available in Tape & Reel (LT)

PIN CONNECTIONS (top view)



TS934IN-TS934ID-TS934IDT-TS934IPT



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ¹⁾	12	V
V_{id}	Differential Input Voltage ²⁾	± 12	V
V_{in}	Input Voltage Range ³⁾	-0.3 to 12.3	V
T_{oper}	Operating Free Air Temperature Range	-40 to + 85	°C
T_{std}	Storage Temperature Range	-65 to +150	°C
T_j	Maximum Junction Temperature	150	°C
R_{thjc}	Thermal Resistance Junction to Case ⁴⁾ SOT23-5 DIP8 DIP14 SO8 SO14 TSSOP8 TSSOP14	81 42 32 28 22 26 21	°C/W
R_{thja}	Thermal Resistance Junction to Ambient - SOT23-5	256	°C/W
ESD	Human Body Model	2	kV
	Latch-up Immunity	Class A	
	Lead Temperature (soldering, 10sec)	260	°C

1. All voltages values, except differential voltage are with respect to network terminal.
2. Differential voltages are non-inverting input terminal with respect to the inverting input terminal.
3. The magnitude of input and output voltages must never exceed $V_{CC} + 0.3V$.
4. Short-circuits can cause excessive heating and destructive dissipation.

OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	2.7 to 10	V
V_{icm}	Common Mode Input Voltage Range	$V_{ee} - 0.2$ to $V_{CC} - 1.5$	V

ELECTRICAL CHARACTERISTICS $V_{CC} = +3V$, $V_{EE} = 0V$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage TS931/2/4 TS931/2/4A TS931/2/4B			10 5 2	mV
ΔV_{io}	Input Offset Voltage Drift		3		$\mu V/^{\circ}C$
I_{io}	Input Offset Current ¹⁾		1	100	pA
I_{ib}	Input Bias Current ¹⁾		1	150	pA
CMR	Common Mode Rejection Ratio $0 \leq V_{icm} \leq V_{CC} - 1.7$		85		dB
SVR	Supply Voltage Rejection Ratio ²⁾		85		dB
A_{vd}	Large Signal Voltage Gain $V_O = 2V_{pp}$ $R_L = 1M\Omega$ $R_L = 100k\Omega$		120 106		dB
V_{OH}	High Level Output Voltage $V_{ID} = 100mV$ $R_L = 100k\Omega$	2.95			V
V_{OL}	Low Level Output Voltage $V_{ID} = -100mV$ $R_L = 100k\Omega$			50	mV
I_o	Output Source Current $V_{ID} = 100mV$, $V_O = V_{DD}$ Output Sink Current $V_{ID} = -100mV$, $V_O = V_{CC}$		1.5 1.5		mA
I_{CC}	Supply Current (per amplifier) $A_{VCL} = 1$, no load		20	31	μA
GBP	Gain Bandwidth Product $R_L = 100k\Omega$, $C_L = 50pF$		100		kHz
SR	Slew Rate $R_L = 100k\Omega$, $C_L = 50pF$		50		V/ms
ϕ_m	Phase Margin $C_L = 50pF$		65		Degrees
en	Input Voltage Noise		75		nV/ $\sqrt{Hz}$

1. Maximum values including unavoidable inaccuracies of the industrial test.

2. V_{CC} has a 0.2V variation.

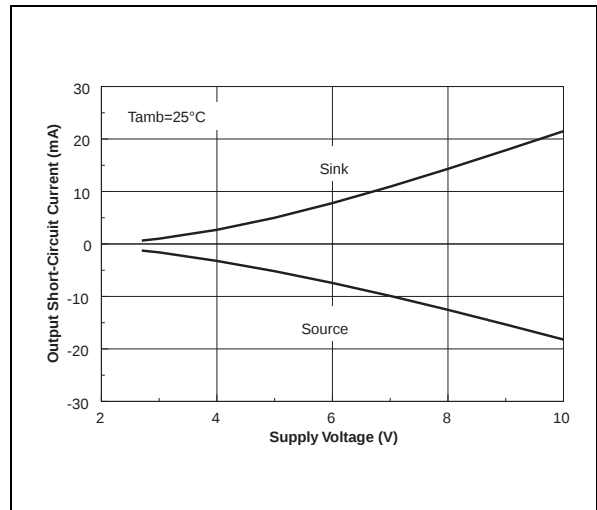
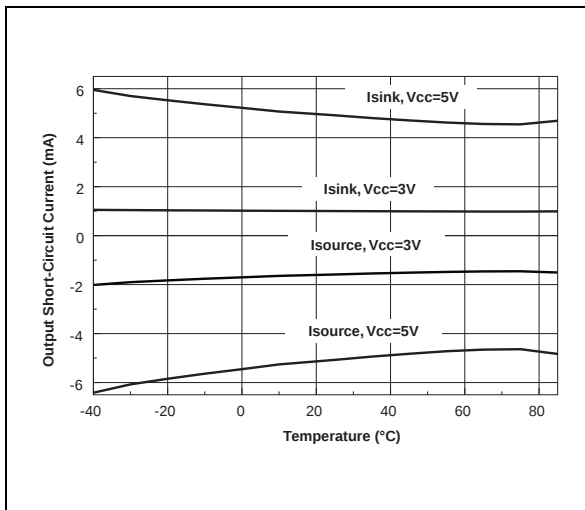
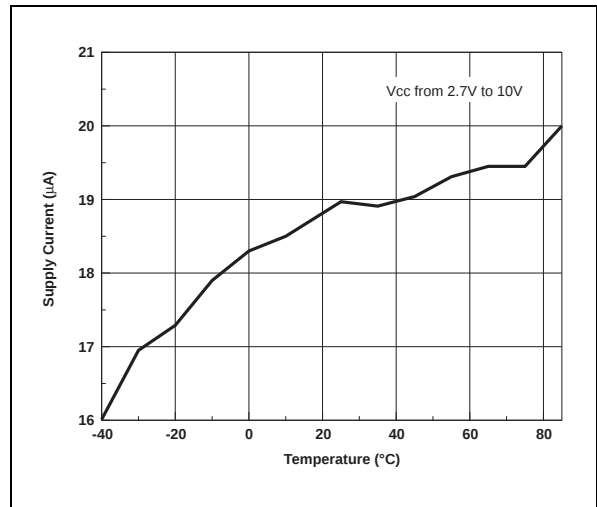
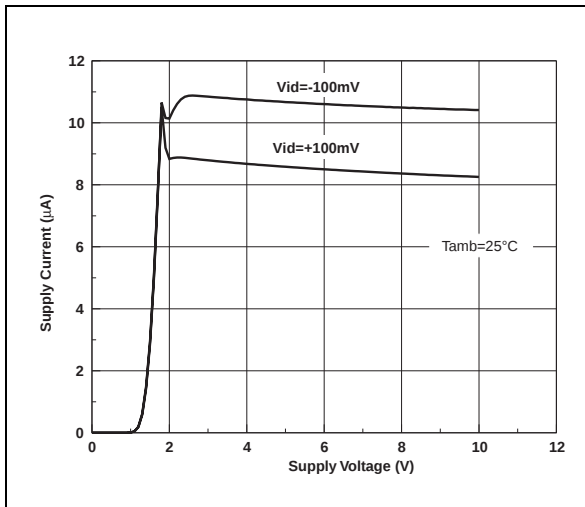
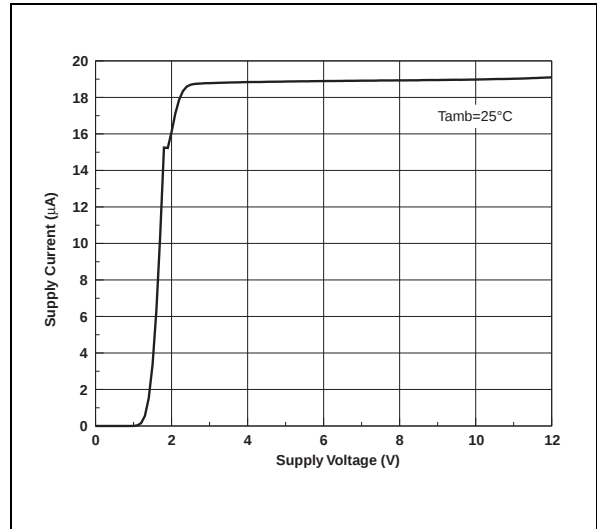
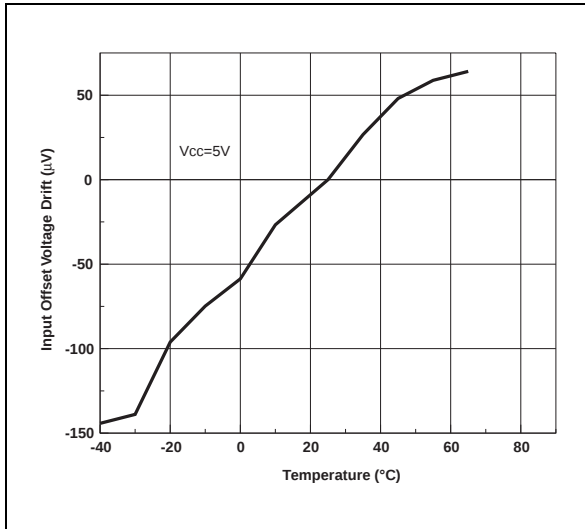
ELECTRICAL CHARACTERISTICS
 $V_{CC} = +5V$, $V_{EE} = 0V$,

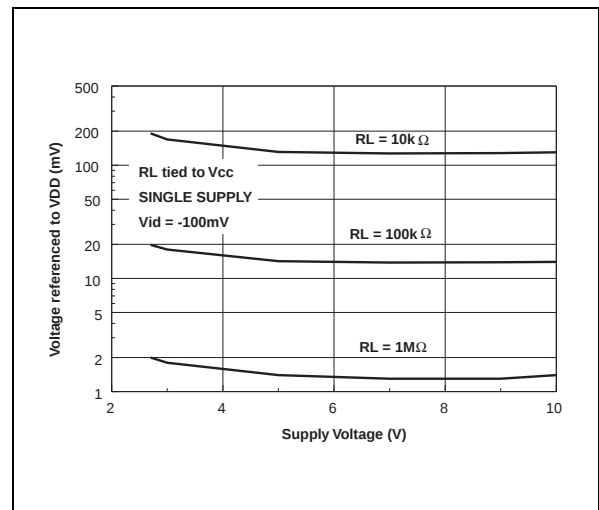
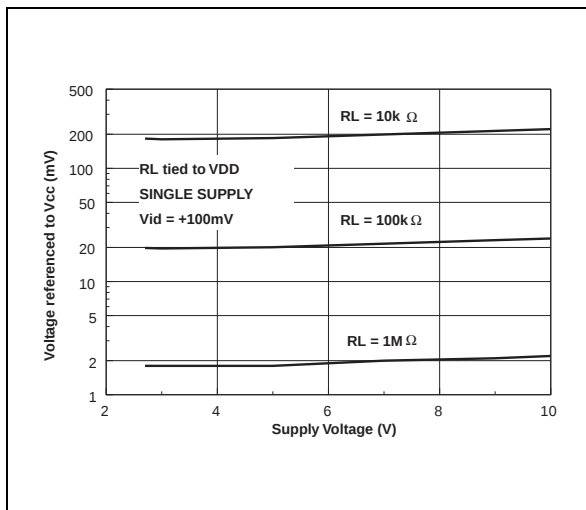
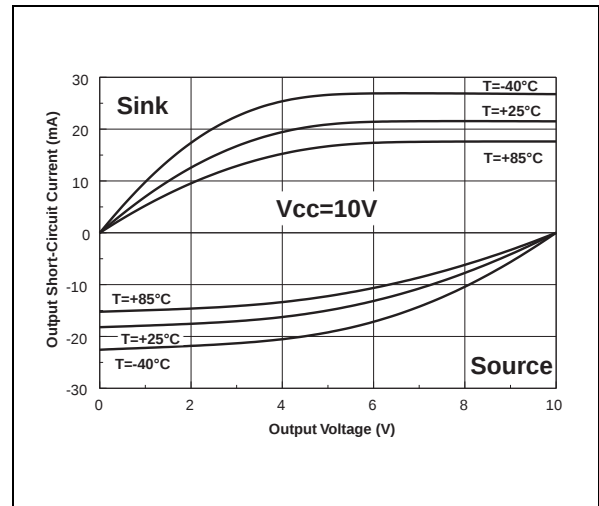
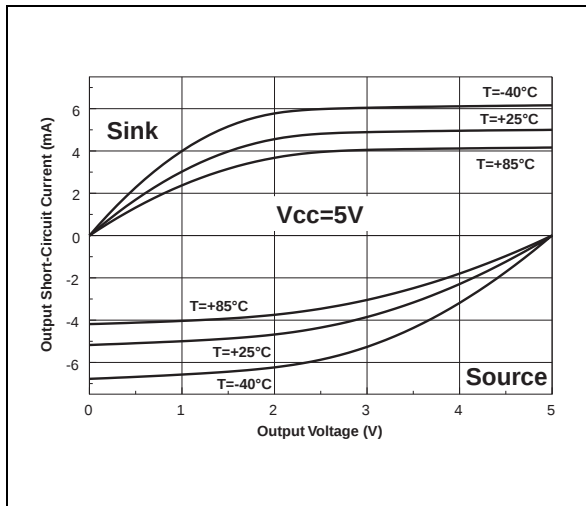
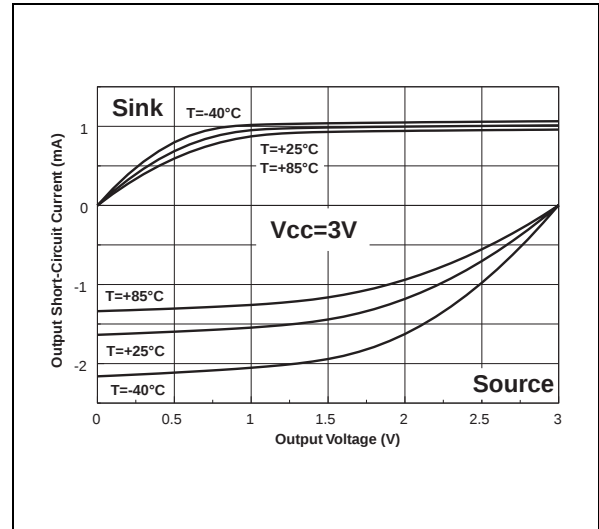
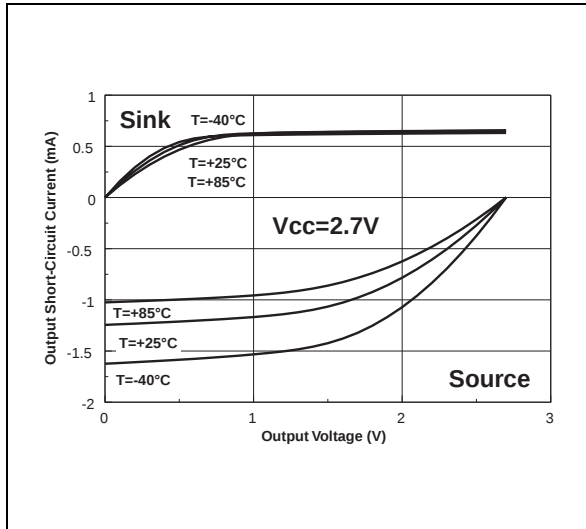
 $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

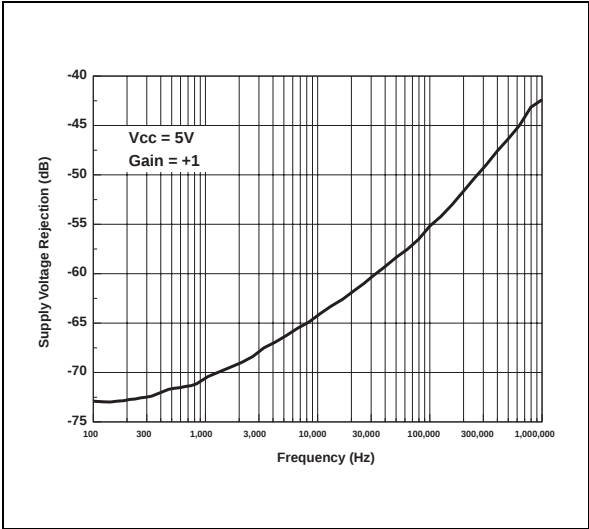
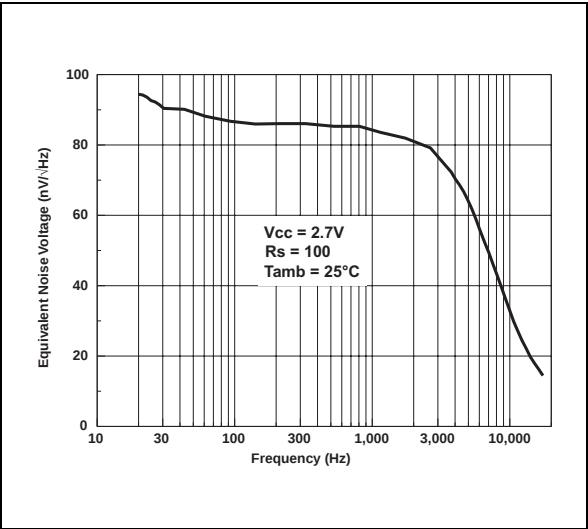
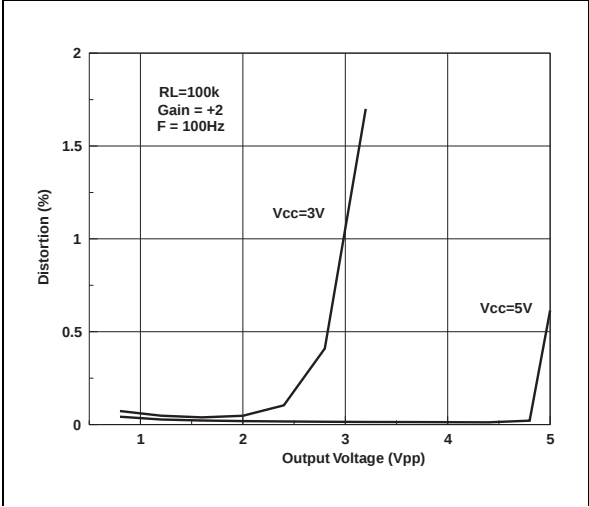
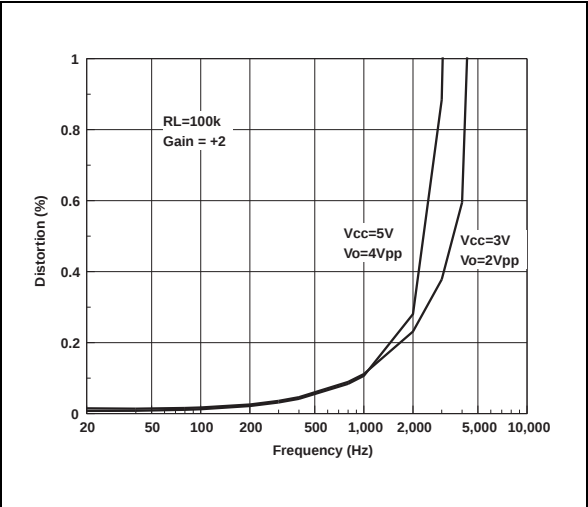
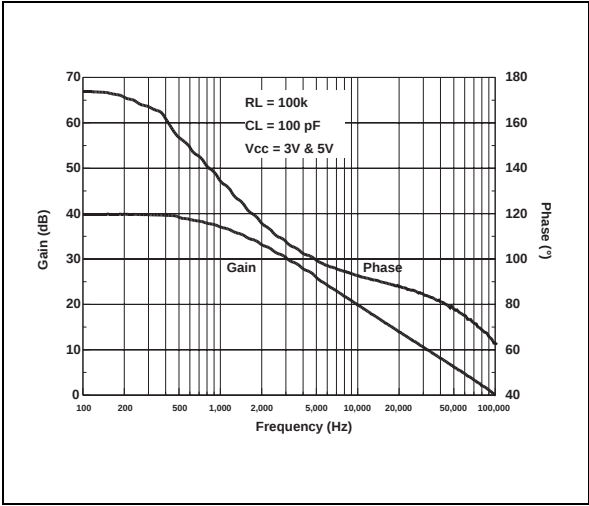
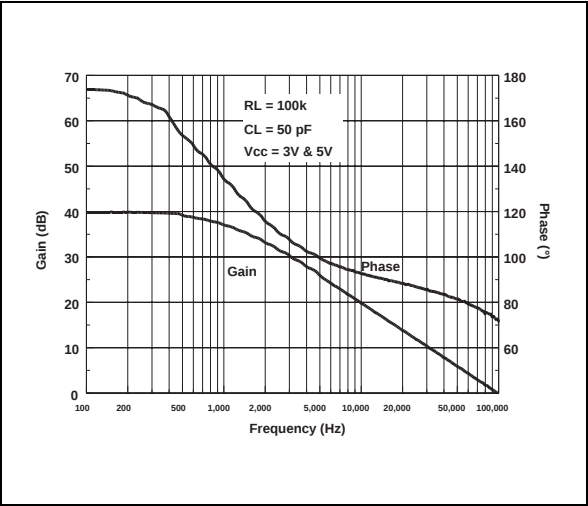
Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage TS931/2/4 TS931/2/4A TS931/2/4B			10 5 2	mV
ΔV_{io}	Input Offset Voltage Drift		3		$\mu V/^{\circ}C$
I_{io}	Input Offset Current ¹⁾		1	100	pA
I_{ib}	Input Bias Current ¹⁾		1	150	pA
CMR	Common Mode Rejection Ratio $0 \leq V_{icm} \leq V_{CC} - 1.7$		85		dB
SVR	Supply Voltage Rejection Ratio ²⁾		85		dB
A_{vd}	Large Signal Voltage Gain $V_O = 4V_{pp}$ $R_L = 1M\Omega$ $R_L = 100k\Omega$		120 112		dB
V_{OH}	High Level Output Voltage $V_{ID} = 100mV$ $R_L = 100k\Omega$	4.95			V
V_{OL}	Low Level Output Voltage $V_{ID} = -100mV$ $R_L = 100k\Omega$			50	mV
I_o	Output Source Current $V_{ID} = 100mV$, $V_O = V_{DD}$ Output Sink Current $V_{ID} = -100mV$, $V_O = V_{CC}$		5 5		mA
I_{CC}	Supply Current (per amplifier) $A_{VCL} = 1$, no load		20	33	μA
GBP	Gain Bandwidth Product $R_L = 100K\Omega$, $C_L = 50pF$		100		kHz
SR	Slew Rate $R_L = 100K\Omega$, $C_L = 50pF$		50		V/ms
ϕ_m	Phase Margin $C_L = 50pF$		65		Degrees
en	Input Voltage Noise		76		nV/ $\sqrt{Hz}$

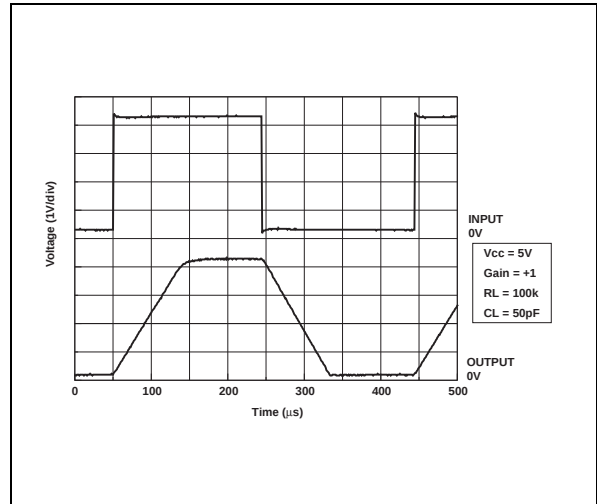
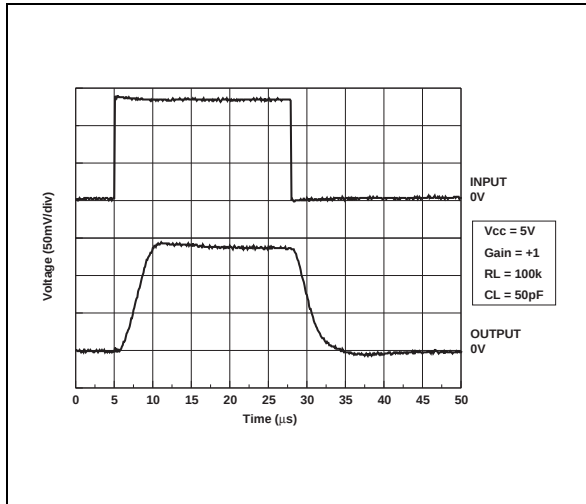
1. Maximum values including unavoidable inaccuracies of the industrial test.

2. V_{CC} has a 0.2V variation.

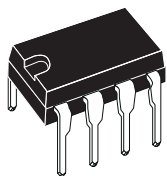




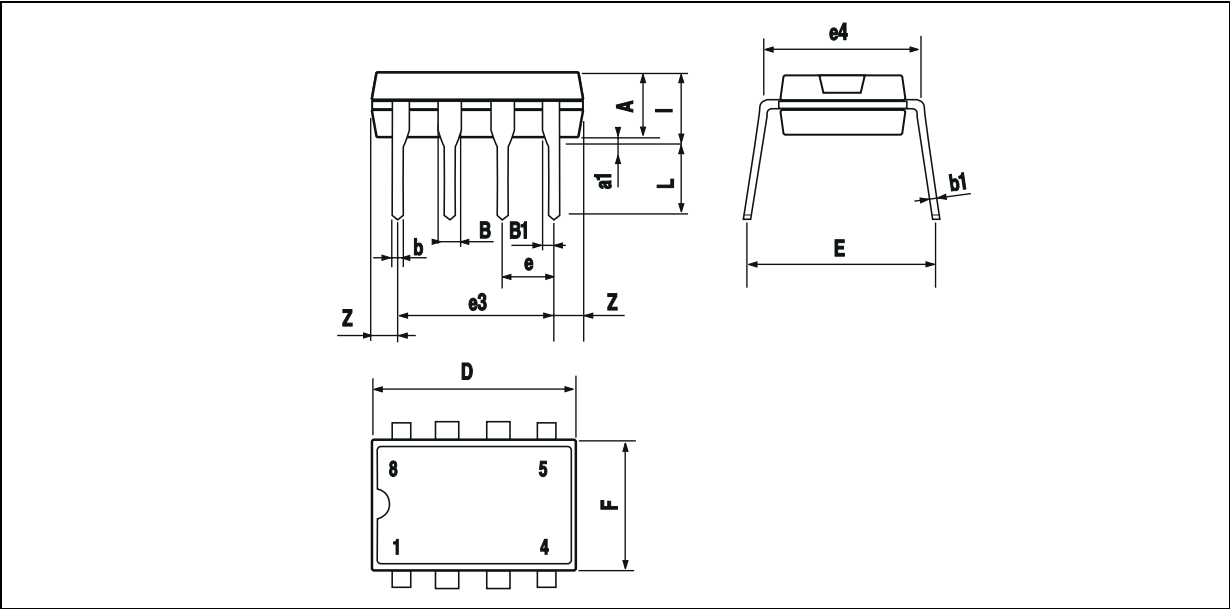




TS932IN

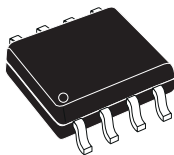


PACKAGE MECHANICAL DATA
8 PINS - PLASTIC PACKAGE

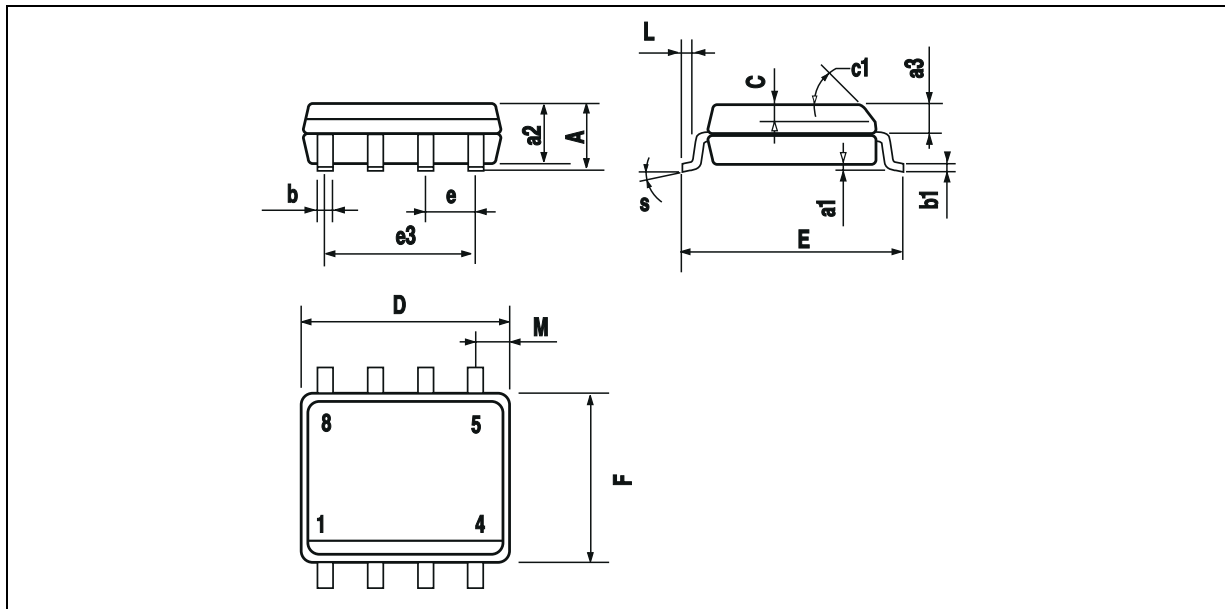


Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

TS931ID - TS932ID

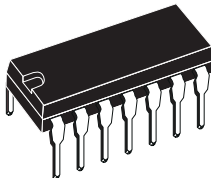
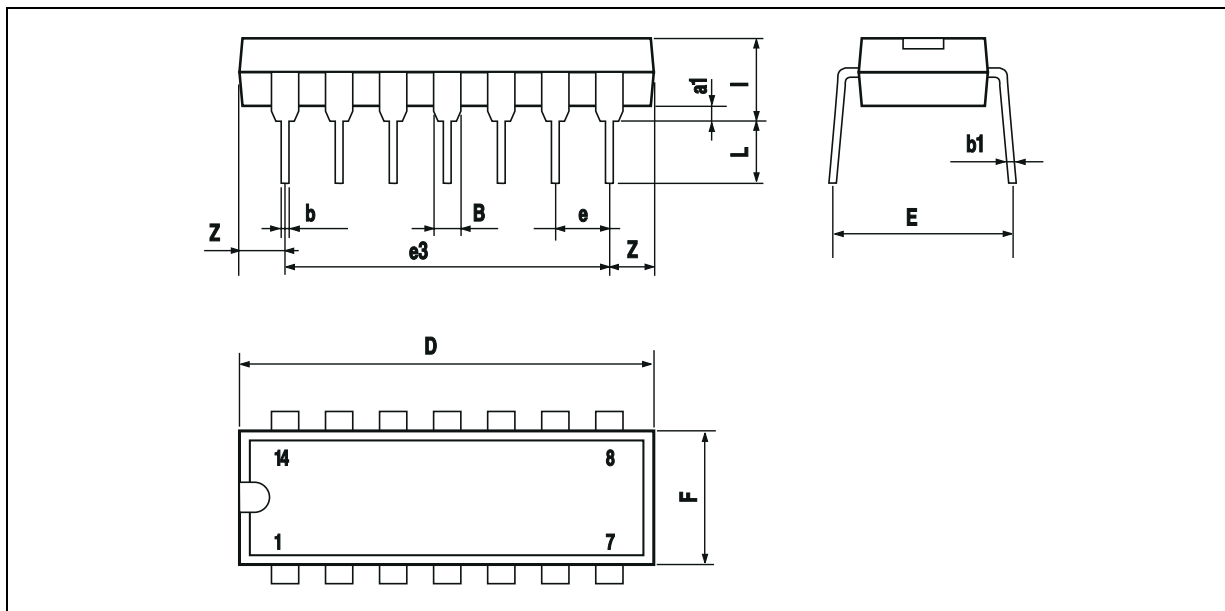
**PACKAGE MECHANICAL DATA**

8 PINS - PLASTIC MICROPACKAGE (SO)



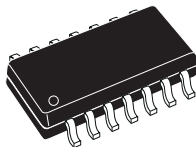
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

TS934IN


PACKAGE MECHANICAL DATA
 14 PINS - PLASTIC PACKAGE


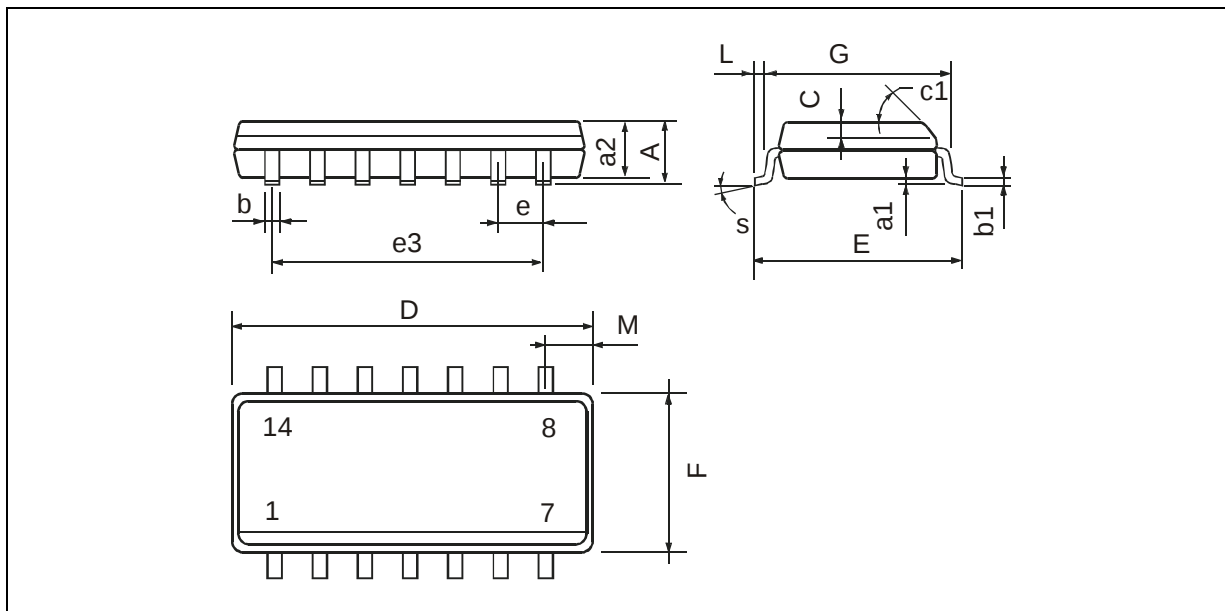
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
i			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

TS934ID



PACKAGE MECHANICAL DATA

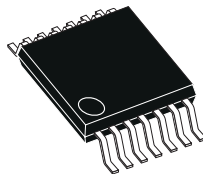
14 PINS - PLASTIC MICROPACKAGE (SO)



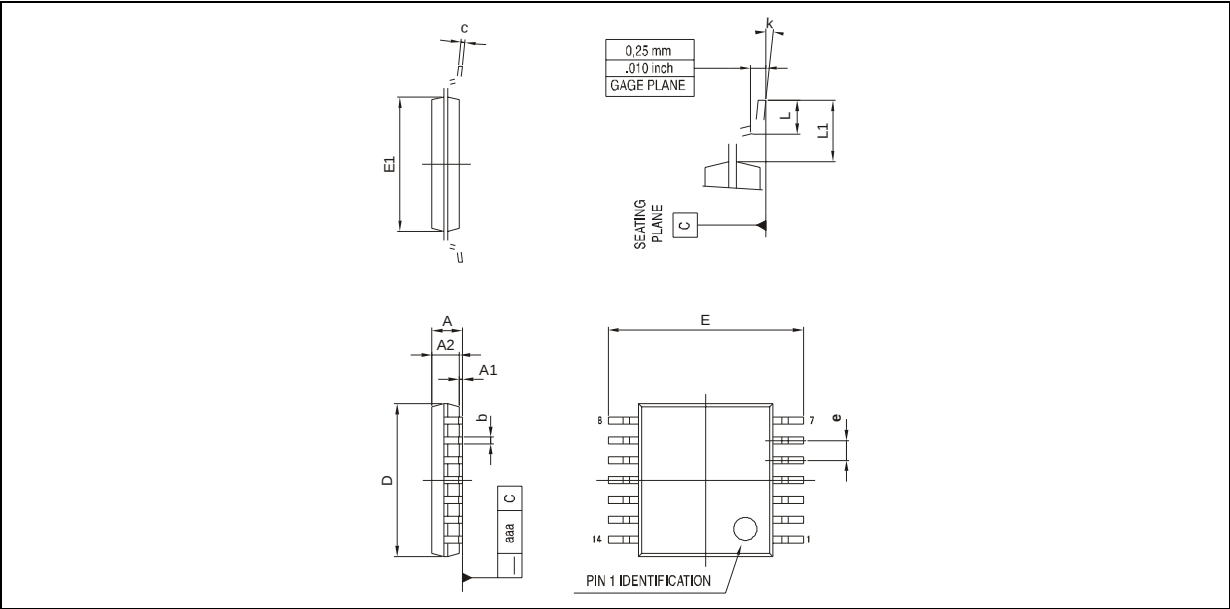
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.2	0.004		0.008
a2			1.6			0.063
b	0.35		0.46	0.014		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.020	
c1	45° (typ.)					
D (1)	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F (1)	3.8		4.0	0.150		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.020		0.050
M			0.68			0.027
S	8° (max.)					

Note : (1) D and F do not include mold flash or protrusions - Mold flash or protrusions shall not exceed 0.15mm (.066 inc) ONLY FOR DATA BOOK.

TS934IPT

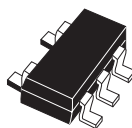
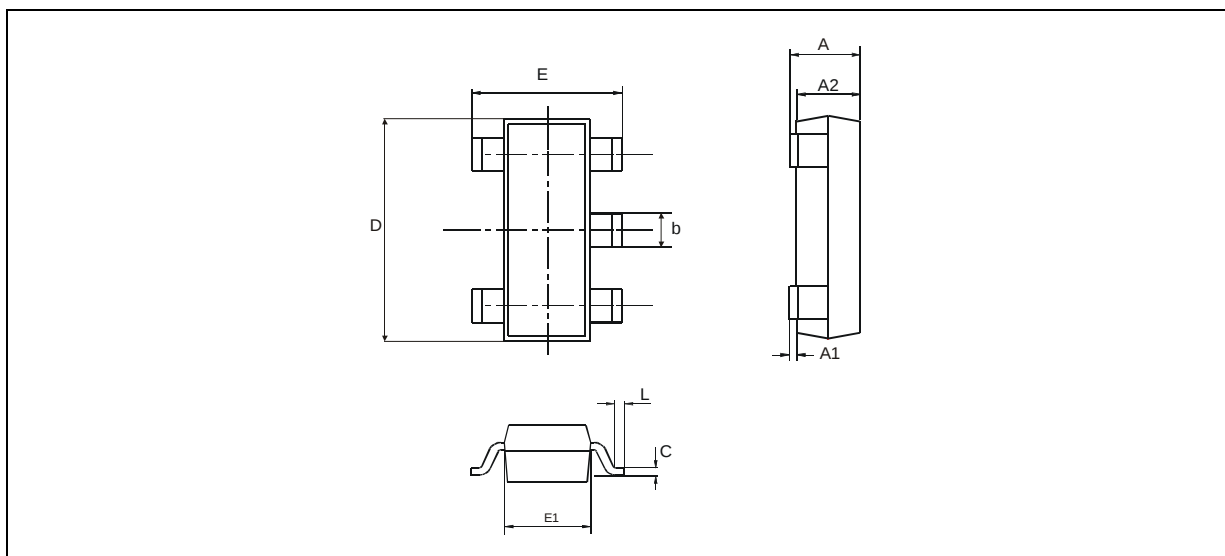


PACKAGE MECHANICAL DATA
14 PINS - THIN SHRINK SMALL OUTLINE PACKAGE



Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.20			0.05
A1	0.05		0.15	0.01		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.15
c	0.09		0.20	0.003		0.012
D	4.90	5.00	5.10	0.192	0.196	0.20
E		6.40			0.252	
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.025	
k	0°		8°	0°		8°
l	0.50	0.60	0.75	0.09	0.0236	0.030

TS931ILT


PACKAGE MECHANICAL DATA
 5 PINS - TINY PACKAGE (SOT23)


Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90	1.20	1.45	0.035	0.047	0.057
A1	0		0.15			0.006
A2	0.90	1.05	1.30	0.035	0.041	0.051
B	0.35	0.40	0.50	0.014	0.016	0.020
C	0.09	0.15	0.20	0.004	0.006	0.008
D	2.80	2.90	3.00	0.110	0.114	0.118
D1		1.90			0.075	
e		0.95			0.037	
E	2.60	2.80	3.00	0.102	0.110	0.0118
F	1.50	1.60	1.75	0.059	0.063	0.069
L	0.10	0.5	0.60	0.004	0.014	0.024
K	0d		10d	0d		10d

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